



RECOMMENDED PCB LAYOUT
PCB图仅供参考

- Note:
1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
 - 1.2 Contact: copper alloy,t=0.15mm
 - 1.3 Shell: copper alloy,t=0.25mm
 2. Specification:
 - 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C

凱帛企業有限公司
KABO ENTERPRISE CO., LTD.

DESCRIPTION(內容)
Micro USB B母 SMT R/A 5PIN 黑膠
LCP 銅殼 四腳全貼 沉板式1.17

PART NO:
(料號) Micro USB-B-1091-0593N

DWG NO(圖號):

DRAWN(製圖)
CHECKED(確認):
APPROVAL(核准):

GENERAL TOLERANCE:
(公差)

X	±0.30	X	±5°
X	±0.25	X	±2°
XX	±0.15	XX	±1°
XXX	±0.10	XXX	±0.5°

SCALE(比例):
1:XX

REV:	REV	DESCRIPTION	DATE
A	1		2018.10.18
UNIT:	2		
mm	3		
SIZE:	4		
A4			
SHEET:			
1/1			